

GE1001, GE1002 GE1003, GE1004

December 1993

1A, 50V - 200V Ultrafast Diodes

Features:

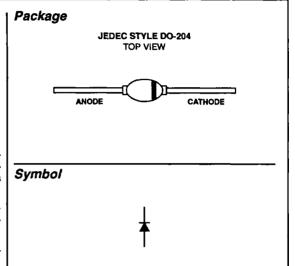
- · Glass Passivated Junction
- Ultra-Fast Recovery Times
- . Low Forward Voltage Drop, High-Current Capability
- · Low Reverse Current Leakage
- High Surge Current Capability

Description

The GE1001, GE1002, GE1003, and GE1004 are ultra-fast-recovery silicon rectifiers (t_{RR} = 35ns max.) featuring low forward voltage drop, high-current capability. They use glass passivated epitaxial construction.

These rectifiers are intended for TV deflection, inverter, high-frequency power supplies, energy recovery, and output rectification.

These types are supplied in unitized-glass hermeticallysealed JEDEC style DO-204 package.



| Absolute Maximum Hatings Supply Frequency of 60Hz, i | Resistive or Induct | live Loads, Note | 1 | | |
|--|---------------------|------------------|-------------|-------------|-------|
| | GE1001 | GE1002 | GE1003 | GE1004 | UNITS |
| Maximum Peak Repetitive Reverse VoltageV _F | RRM 50 | 100 | 150 | 200 | ٧ |
| Maximum RMS Input (Supply) Voltage | RMS 35 | 70 | 105 | 140 | ٧ |
| Maximum DC Reverse (Blocking) Voltage VR | (DC) 50 | 100 | 150 | 200 | ٧ |
| Maximum Average Forward Output Current Lead Length = 0.375 in. (9.5mm); $T_A = 55^{\circ}C$ | .l ₀ 1 | 1 | 1 | 1 | A |
| Maximum Peak Surge (Non-Repetitive) Forward Current | _ | | | | |
| For 8.3ms Half Sine Wave, Superimposed on Rated Load, I | -SM 30 | 30 | 30 | 30 | A |
| Operating Junction and Storage Temperature | STG -65 to +175 | -65 to +175 | -65 to +175 | -65 to +175 | °C |

1. For capacitive load derate current by 20%.

Specifications GE1001, GE1002, GE1003, GE1004

Electrical Specifications T_A = +25°C, Unless Otherwise Specified

| PARAMETERS | | LIMITS FOR ALL TYPES | | | |
|--|-----------------|----------------------|-----|------|-------|
| | SYMBOL | MIN | TYP | MAX | UNITS |
| Maximum Instantaneous Forward-Voltage Drop at 1A | V _F | - | - | 0.95 | V |
| Maximum Reverse Current | | | _ | | |
| At Maximum DC Reverse (Blocking) Voltage, T _A = +25°C | I _R | - | - ' | 2 | μА |
| At Maximum DC Reverse (Blocking) Voltage, T _A = +150°C | I _R | | | 50 | μА |
| Maximum Reverse Recovery Time | | | | | |
| At I _F = 0.5A, I _R = 1A, I _{RR} = 0.25A | t _{AA} | • | | 35 | ns |
| Typical Junction Capacitance | | | | | |
| At Frequency 1MHz and Applied Reverse Voltage = 4V | C¹ | - | 45 | - | pF |
| Thermal Resistance | | | | | |
| Junction-to-Ambient at 0.375 in. (9.5mm) Lead Length | PINA | - | - | 65 | °C/W |

Typical Performance Curves

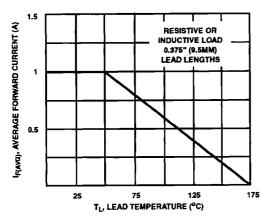


FIGURE 1. MAXIMUM AVERAGE FORWARD OUTPUT CURRENT CHARACTERISTIC

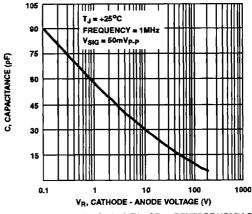


FIGURE 2. JUNCTION CAPACITANCE VS REVERSE VOLTAGE

Typical Performance Curves (Continued)

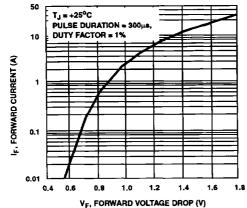


FIGURE 3. TYPICAL INSTANTANEOUS FORWARD CURRENT CHARACTERISTIC

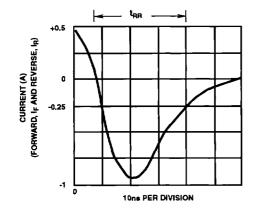


FIGURE 5. REVERSE-RECOVERY TIME WAVEFORM

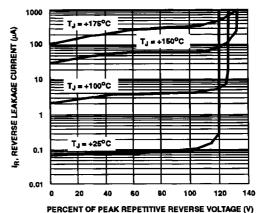


FIGURE 4. TYPICAL REVERSE LEAKAGE CURRENT CHARACTERISTICS

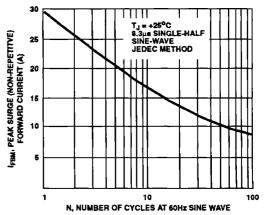
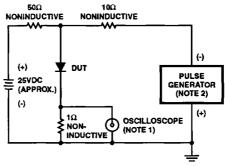


FIGURE 6. PEAK SURGE CAPABILITY VS NUMBER OF CYCLES



NOTES:

- 1. RISE TIME = 7ns MAX., INPUT IMPEDANCE = 1MQ, 22pF
- 2. RISE TIME = 10ns MAX., SOURCE IMPEDANCE = 50Ω

FIGURE 7. REVERSE-RECOVERY TIME TEST CIRCUIT